

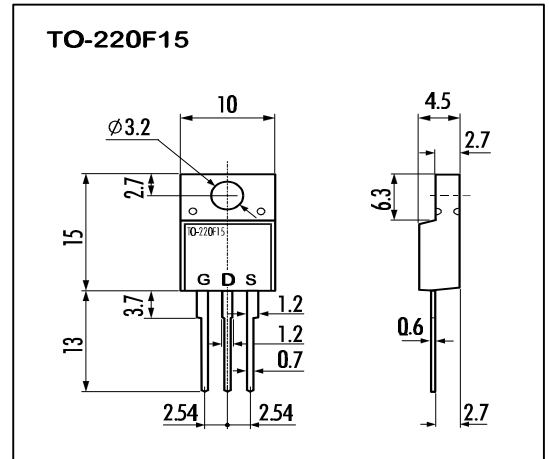
**> Features**

- High Speed Switching
- Low On-Resistance
- No Secondary Breakdown
- Low Driving Power
- High Voltage
- $V_{GS} = \pm 30V$  Guarantee
- Repetitive Avalanche Rated

**> Applications**

- Switching Regulators
- UPS
- DC-DC converters
- General Purpose Power Amplifier

**> Outline Drawing**



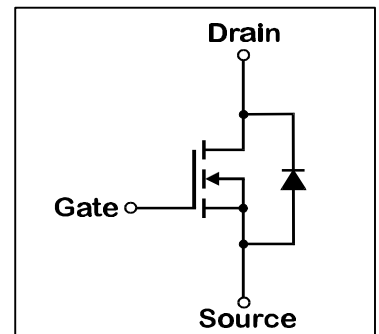
**> Maximum Ratings and Characteristics**

- Absolute Maximum Ratings ( $T_C=25^\circ C$ ), unless otherwise specified

| Item   | Symbol        | Rating     | Unit       |
|--|---------------|------------|------------|
| Drain-Source-Voltage                                       | $V_{DS}$      | 500        | V          |
| Continuous Drain Current                                   | $I_D$         | ±6         | A          |
| Pulsed Drain Current                                       | $I_{D(puls)}$ | ±24        | A          |
| Gate-Source-Voltage  | $V_{GS}$      | ±35        | V          |
| Repetitive or Non-Repetitive ( $T_{ch} \leq 150^\circ C$ ) | $I_{AR}$      | 6          | A          |
| Avalanche Energy   | $E_{AS}$      | 196.9      | mJ         |
| Max. Power Dissipation                                     | $P_D$         | 30         | W          |
| Operating and Storage Temperature Range                    | $T_{ch}$      | 150        | $^\circ C$ |
|  | $T_{stg}$     | -55 ~ +150 | $^\circ C$ |

$L=10.0mH, V_{CC}=50V$

**> Equivalent Circuit**



- Electrical Characteristics ( $T_C=25^\circ C$ ), unless otherwise specified

| Item   | Symbol       | Test conditions                             | Min. | Typ. | Max. | Unit     |
|--|--------------|---|------|------|------|----------|
| Drain-Source Breakdown-Voltage                   | $BV_{DSS}$   | $I_D=1mA, V_{GS}=0V$                        | 500  |      |      | V        |
| Gate Threshold Voltage                           | $V_{GS(th)}$ | $I_D=1mA, V_{DS}=V_{GS}$                    | 3,5  | 4,0  | 4,5  | V        |
| Zero Gate Voltage Drain Current                  | $I_{DSS}$    | $V_{DS}=500V, T_{ch}=25^\circ C$            |      | 10   | 500  | $\mu A$  |
|  |              | $V_{GS}=0V, T_{ch}=125^\circ C$             |      | 0,2  | 1,0  | mA       |
| Gate Source Leakage Current                      | $I_{GSS}$    | $V_{GS}=\pm 35V, V_{DS}=0V$                 |      | 10   | 100  | nA       |
| Drain Source On-State Resistance                 | $R_{DS(on)}$ | $I_D=3A, V_{GS}=10V$                        |      | 1,25 | 1,5  | $\Omega$ |
| Forward Transconductance                         | $g_{fs}$     | $I_D=3A, V_{DS}=25V$                        | 2    | 4    |      | S        |
| Input Capacitance                                | $C_{iss}$    | $V_{DS}=25V$                                |      | 540  | 810  | pF       |
| Output Capacitance                               | $C_{oss}$    | $V_{GS}=0V$                                 |      | 100  | 150  | pF       |
| Reverse Transfer Capacitance                     | $C_{rss}$    | $f=1MHz$                                    |      | 45   | 70   | pF       |
| Turn-On-Time $t_{on} (t_{on}=t_{d(on)}+t_r)$     | $t_{d(on)}$  | $V_{CC}=300V, I_D=6A$                       |      | 13   | 20   | ns       |
|  | $t_r$        | $V_{GS}=10V, R_{GS}=10\Omega$               |      | 40   | 60   | ns       |
| Turn-Off-Time $t_{off} (t_{off}=t_{d(off)}+t_f)$ | $t_{d(off)}$ |   |      | 30   | 45   | ns       |
|  | $t_f$        |   |      | 25   | 40   | ns       |
| Avalanche Capability                             | $I_{AV}$     | $L = 10,0mH, T_{ch}=25^\circ C$             | 6    |      |      | A        |
| Diode Forward On-Voltage                         | $V_{SD}$     | $I_F=2I_{DR}, V_{GS}=0V, T_{ch}=25^\circ C$ |      | 1,0  | 1,5  | V        |
| Reverse Recovery Time                            | $t_{rr}$     | $I_F=I_{DR}, V_{GS}=0V$                     |      | 450  |      | ns       |
| Reverse Recovery Charge                          | $Q_{rr}$     | $-di_F/dt=100A/\mu s, T_{ch}=25^\circ C$    |      | 3,2  |      | $\mu C$  |

- Thermal Characteristics

| Item               | Symbol         | Test conditions | Min. | Typ. | Max. | Unit         |
|--------------------|----------------|-----------------|------|------|------|--------------|
| Thermal Resistance | $R_{th(ch-c)}$ | channel to case |      |      | 4,17 | $^\circ C/W$ |
|                    | $R_{th(ch-a)}$ | channel to air  |      |      | 62,5 | $^\circ C/W$ |

|                   |      |     |     |
|-------------------|------|-----|-----|
| N-channel MOS-FET |      |     |     |
| 500V              | 1,5Ω | ±6A | 30W |

# 2SK2876-01MR

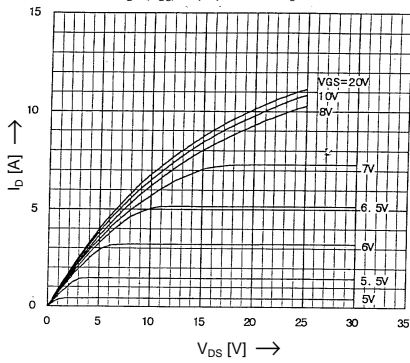
## FAP-IIS Series



### > Characteristics

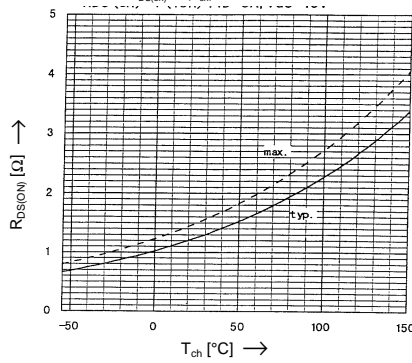
Typical Output Characteristics

$I_D = f(V_{DS})$ ; 80μs pulse test;  $T_C = 25^\circ\text{C}$



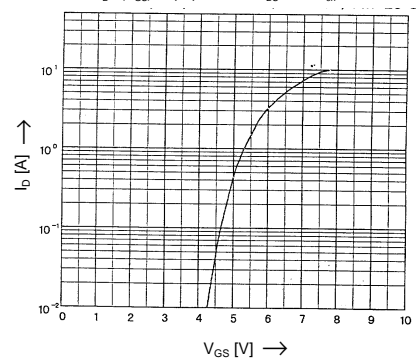
Drain-Source-On-State Resistance vs.  $T_{ch}$

$R_{DS(on)} = f(T_{ch})$ ;  $I_D = 3\text{A}$ ;  $V_{GS} = 10\text{V}$



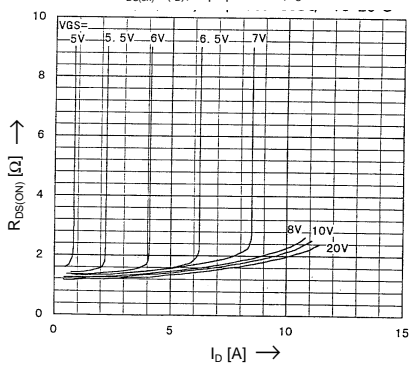
Typical Transfer Characteristics

$I_D = f(V_{GS})$ ; 80μs pulse test;  $V_{DS} = 25\text{V}$ ;  $T_{ch} = 25^\circ\text{C}$



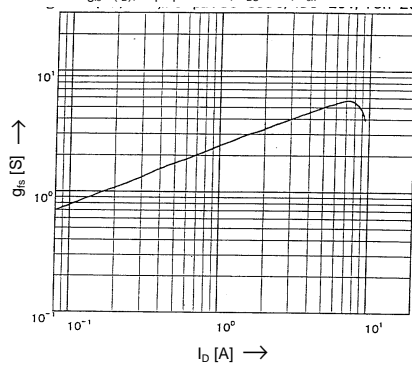
Typical Drain-Source-On-State-Resistance vs.  $I_D$

$R_{DS(on)} = f(I_D)$ ; 80μs pulse test;  $T_C = 25^\circ\text{C}$



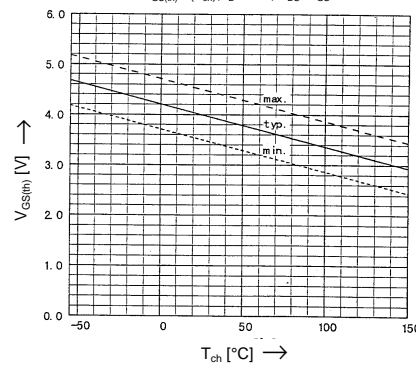
Typical Forward Transconductance vs.  $I_D$

$g_{fs} = f(I_D)$ ; 80μs pulse test;  $V_{DS} = 25\text{V}$ ;  $T_{ch} = 25^\circ\text{C}$



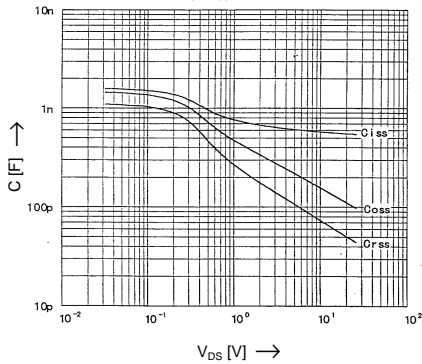
Gate Threshold Voltage vs.  $T_{ch}$

$V_{GS(th)} = f(T_{ch})$ ;  $I_D = 1\text{mA}$ ;  $V_{DS} = V_{GS}$



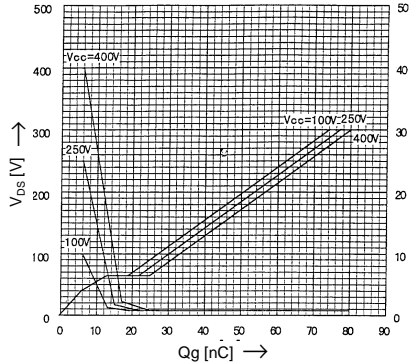
Typical Capacitances vs.  $V_{DS}$

$C = f(V_{DS})$ ;  $V_{GS} = 0\text{V}$ ;  $f = 1\text{MHz}$



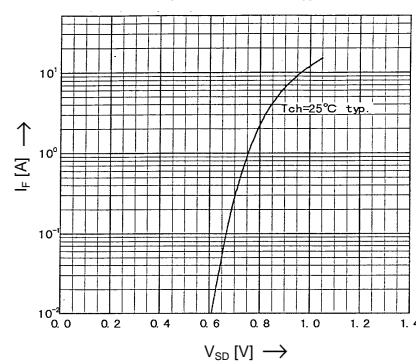
Typical Gate Charge Characteristic

$V_{GS} = f(Q_g)$ ;  $I_D = 6\text{A}$ ;  $T_C = 25^\circ\text{C}$



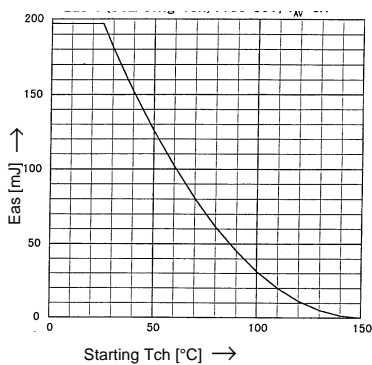
Forward Characteristics of Reverse Diode

$I_F = f(V_{SD})$ ; 80μs pulse test;  $V_{GS} = 0\text{V}$



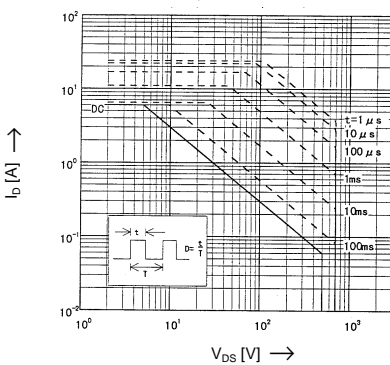
Avalanche Energy Derating

$E_{as} = f(\text{starting } T_{ch})$ ;  $V_{CC} = 50\text{V}$ ;  $I_{AV} = 6\text{A}$



Safe operation area

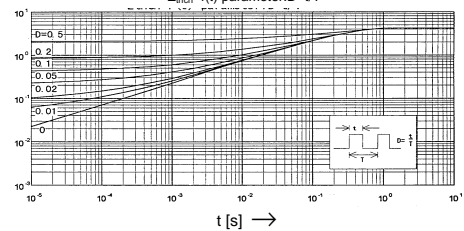
$I_D = f(V_{DS})$ ;  $D = 0.01$ ;  $T_C = 25^\circ\text{C}$



$Z_{th(ch-e)}$  [K/W]

Transient Thermal impedance

$Z_{th(ch-e)} = f(t)$  parameter:  $D = t/T$



N-channel MOS-FET

500V 1,5Ω ±6A 30W

**2SK2876-01MR**  
FAP-IIS Series

**FUJI**  
ELECTRIC

> Characteristics

